

## **General Description**

The HCSD19531Q5A use advanced SGT MOSFET technology to provide low RDS(ON), low gate charge, fast switching and excellent avalanche characteristics.

This device is specially designed to get better ruggedness and suitable to use in

#### **General Features**

V<sub>DS</sub> =100V I<sub>D</sub> =75A

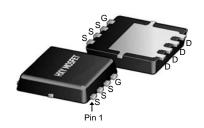
 $R_{DS(ON)}$  < 9.2m $\Omega$  @  $V_{GS}$ =10V

## **Applications**

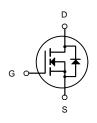
Consumer electronic power supply Motor control

Synchronous-rectification Isolated DC

Synchronous-rectification applications



DFN5X6-8L (DFN-8(4.9x5.8))



N-Channel MOSFET

## **Package Marking and Ordering Information**

Product ID	Pack	Brand	Qty(PCS)
HCSD19531Q5A	DFN5X6-8L(DFN-8(4.9x5.8))	HXY MOSFET	5000

## **Absolute Maximum Ratings** at T<sub>j</sub>=25°C unless otherwise noted

Parameter	Symbol	Value	Unit
Drain source voltage	VDS	100	V
Gate source voltage	VGS	±20	V
Continuous drain current <sup>1)</sup>	ID	75	А
Pulsed drain current <sup>2)</sup>	ID, pulse	300	А
Power dissipation <sup>3)</sup>	P <sub>D</sub>	97	W
Single pulsed avalanche energy <sup>5)</sup>	EAS	90	mJ
Operation and storage temperature	Tstg, Tj	-55 to 150	°C
Thermal resistance, junction-case	RθJC	1.3	°C/W



# **Electrical Characteristics** (T<sub>J</sub>=25 ℃unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
Off Charac	cteristic					
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	100	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =100V, V <sub>GS</sub> =0V,	-	-	1.0	μA
I <sub>GSS</sub>	Gate to Body Leakage Current	V <sub>DS</sub> =0V, V <sub>GS</sub> = ±20V	-	-	±100	nA
On Charac	cteristics					
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	1.0	1.6	2.5	V
	Static Drain-Source on-Resistance	V <sub>GS</sub> =10V, I <sub>D</sub> =20A	-	7.3	9.2	mΩ
$R_{DS(on)}$	note3	V <sub>GS</sub> =4.5V, I <sub>D</sub> =8A -		9	13.5	mΩ
Dynamic (	Characteristics					
C <sub>iss</sub>	Input Capacitance		-	2046	-	pF
Coss	Output Capacitance	V <sub>DS</sub> =50V, V <sub>GS</sub> =0V,	-	865	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	f=1.0MHz	-	25	-	pF
Qg	Total Gate Charge	)/ 50\/ L 00A	-	39.4	-	nC
$Q_gs$	Gate-Source Charge	V <sub>DS</sub> =50V, I <sub>D</sub> =30A, V <sub>GS</sub> =10V	-	5.2	-	nC
$Q_gd$	Gate-Drain("Miller") Charge	VGS-10V	-	9.8	-	nC
Switching	Characteristics					
t <sub>d(on)</sub>	Turn-on Delay Time		-	20	-	ns
t <sub>r</sub>	Turn-on Rise Time	V <sub>DD</sub> =50V, I <sub>D</sub> =25A,	-	5.2	-	ns
$t_{\text{d(off)}}$	Turn-off Delay Time	$R_G=6\Omega$ , $V_{GS}=10V$	-	49	-	ns
$t_f$	Turn-off Fall Time		-	12	-	ns
Drain-Sou	rce Diode Characteristics and Maxim	um Ratings				
I <sub>S</sub>	Maximum Continuous Drain to Source Diode Forward Current			_	75	Α
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current			-	300	Α
$V_{\text{SD}}$	Drain to Source Diode Forward Voltage	V <sub>GS</sub> =0V, I <sub>S</sub> =30A	-	-	1	V
t <sub>rr</sub>	Body Diode Reverse Recovery Time	T25°C	-	49	-	ns
Q <sub>rr</sub>	Body Diode Reverse Recovery Charge	T」=25℃, I <sub>F</sub> =12A,dI/dt=100A/μs	-	85	-	nC

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

<sup>2.</sup> EAS condition: TJ=25  $^{\circ}$ C, VDD=50V, VG=10V, RG=25 $\Omega$ , L=0.5mH, IAS=19A

<sup>3.</sup> Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%



# **Typical Performance Characteristics**

Figure1: Output Characteristics

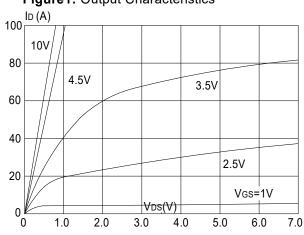


Figure 2: Typical Transfer Characteristics

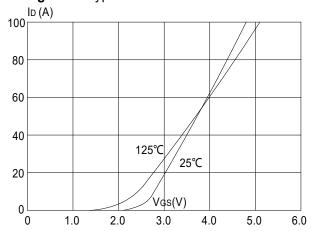


Figure 3:On-resistance vs. Drain Current

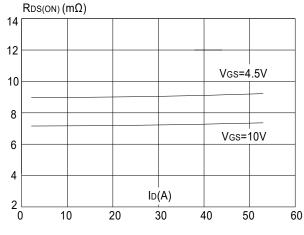


Figure 4: Body Diode Characteristics

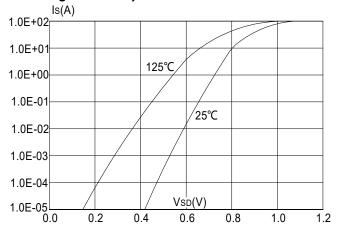


Figure 5: Gate Charge Characteristics

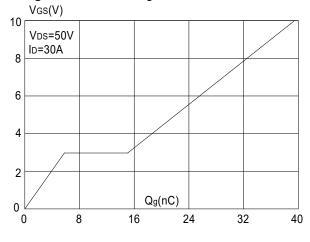
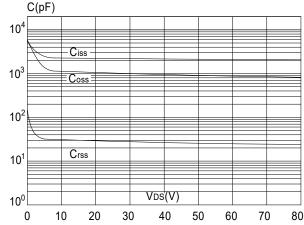


Figure 6: Capacitance Characteristics





**Figure 7:** Normalized Breakdown Voltage vs. Junction Temperature

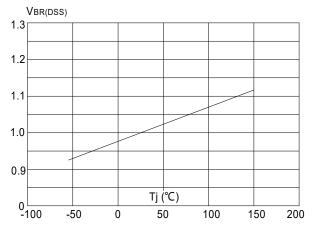
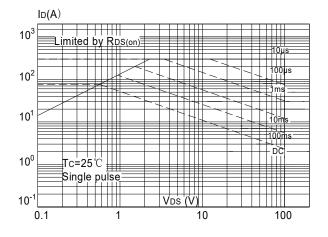
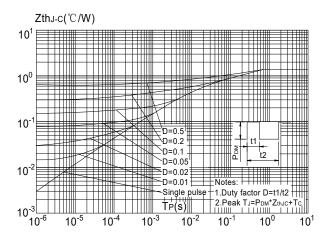


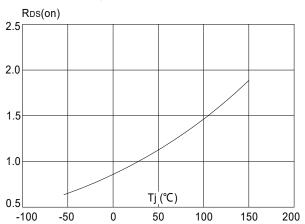
Figure 9: Maximum Safe Operating Area



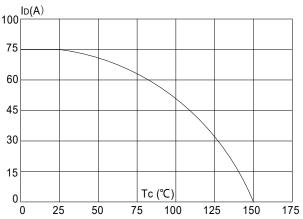
**Figure.11:** Maximum Effective Transient Thermal Impedance, Junction-to-Case



**Figure 8:** Normalized on Resistance vs. Junction Temperature



**Figure 10:** Maximum Continuous Drain Current vs. Case Temperature



## **Test Circuit**

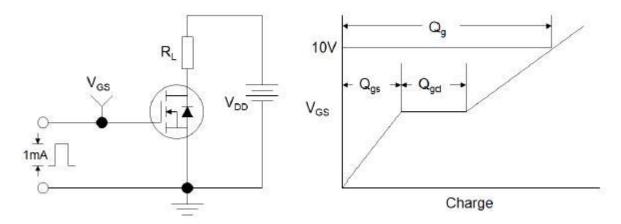


Figure1:Gate Charge Test Circuit & Waveform

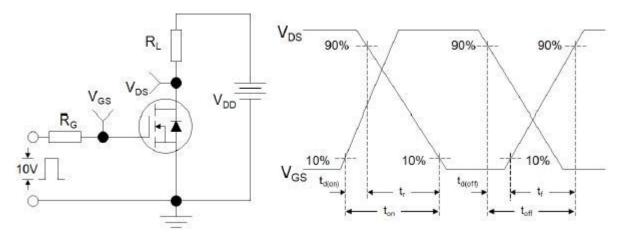


Figure 2: Resistive Switching Test Circuit & Waveforms

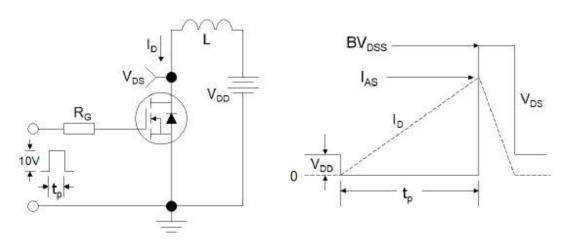
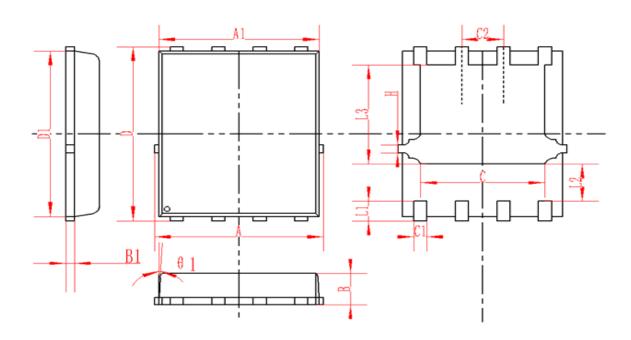


Figure 3:Unclamped Inductive Switching Test Circuit & Waveforms

# DFN5X6-8L(DFN-8(4.9x5.8)) Package Information



SYMBOL	MM		INCH			
	MIN	NOM	MAX	MIN	NOM	MAX
А	4.95	5	5.05	0.195	0.197	0.199
A1	4.82	4.9	4.98	0.190	0.193	0.196
D	5.98	6	6.02	0.235	0.236	0.237
D1	5.67	5.75	5.83	0.223	0.226	0.230
В	0.9	0.95	1	0.035	0.037	0.039
B1	0.254REF		0.010REF			
С	3.95	4	4.05	0.156	0.157	0.159
C1	0.35	0.4	0.45	0.014	0.016	0.018
C2		1.27TYP			0.5TYP	
θ1	8°	10°	12°	8°	10°	12°
L1	0.63	0.64	0.65	0.025	0.025	0.026
L2	1.2	1.3	1.4	0.047	0.051	0.055
L3	3.415	3.42	3.425	0.134	0.135	0.135
Н	0.24	0.25	0.26	0.009	0.010	0.010



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